

Description

The VST10N079 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

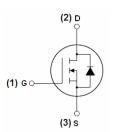
General Features

- V_{DS} =100V, I_D =16A $R_{DS(ON)}$ =7.9m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =9.1m Ω (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification





SOP-8 Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST10N079-S8	VST10N079	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V _G s	±20	V	
Drain Current-Continuous	I _D	16	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	11.3	А	
Pulsed Drain Current	I _{DM}	64	Α	
Maximum Power Dissipation	P _D	3.5	W	
Derating factor		0.028	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	210	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}\!\mathbb{C}$	





Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	36	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.0	1.7	2.2	V
Dunin Course On Chata Benintana	R _{DS(ON)}	V _{GS} =10V, I _D =16A	-	7.9	9.5	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =16A	-	9.1	10.6	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =16A	50	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	V 50VV 0V	-	4960		PF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$	-	389		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	25.3		PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	15.4	-	nS
Turn-on Rise Time	t _r	V_{DD} =50 V , I_D =16 A	-	9.9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	42.9	-	nS
Turn-Off Fall Time	t _f		-	5.5	-	nS
Total Gate Charge	Qg	\/ _F0\/ _46A	-	63.8	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =50V,I _D =16A,	-	16.5	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	8.8	-	nC
Drain-Source Diode Characteristics			•			•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =16A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	16	А
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	105	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	200	-	nC

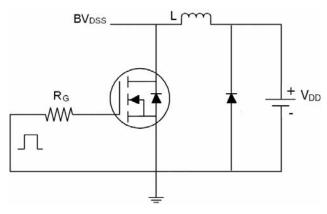
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

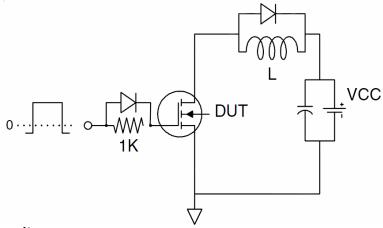


Test Circuit

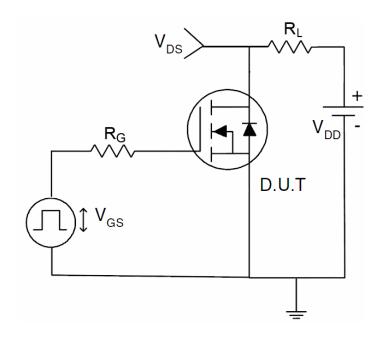
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







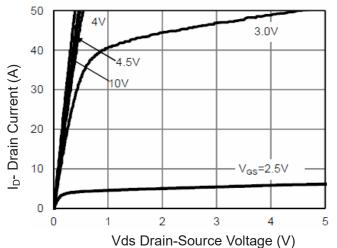


Figure 1 Output Characteristics

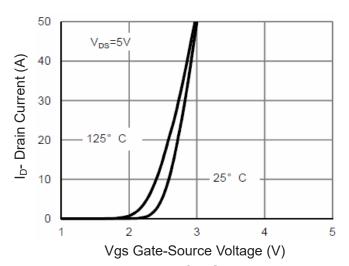


Figure 2 Transfer Characteristics

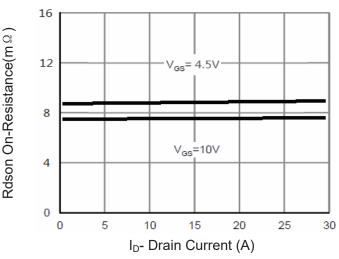


Figure 3 Rdson-Drain Current

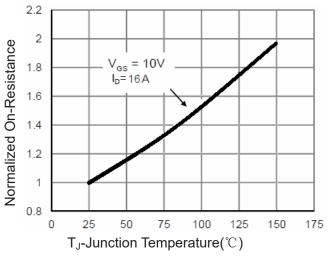


Figure 4 Rdson-Junction Temperature

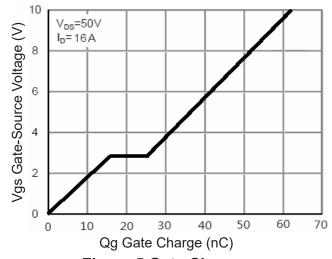


Figure 5 Gate Charge

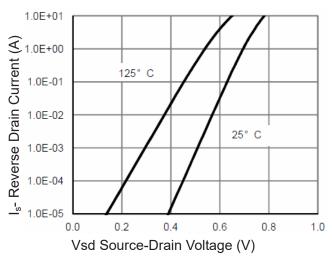
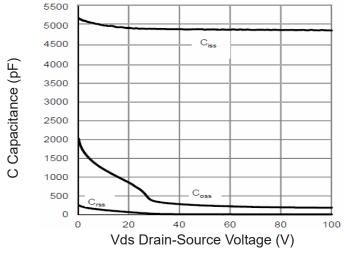


Figure 6 Source- Drain Diode Forward



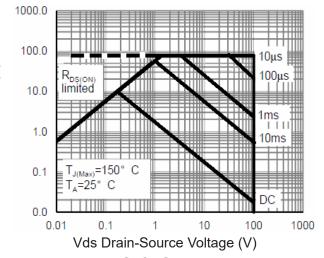
lp- Drain Current (A)



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Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



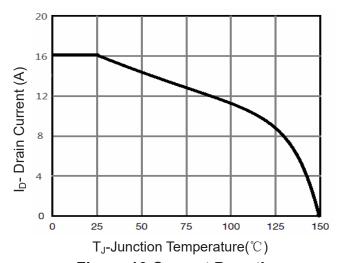
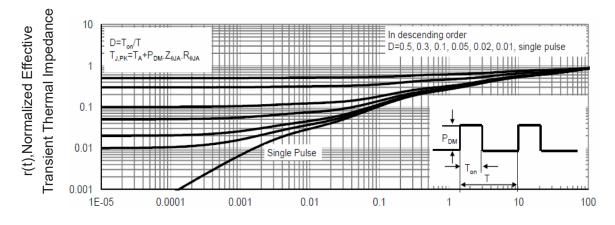


Figure 8 Safe Operation Area

Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance